



Distributor of Texas Instruments: Excellent Integrated System Limited

Datasheet of LMH730036/NOPB - BOARD EVAL DEBUGGING LMH6622MA

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

Excellent Integrated System Limited

Stocking Distributor

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For any questions, you can email us directly:

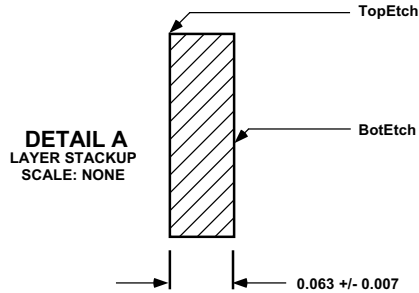
sales@integrated-circuit.com

NOTES: UNLESS OTHERWISE SPECIFIED

1. MATERIAL: PER IPC-4101/24
 - 1A. LAMINATE: HIGH-TEMPERATURE FR4
 - 1B. FINISHED BOARD: .0020 +/- .0005 INCH OUTSIDE LAYERS, COPPER.
 - 1C. ALL COPPER LAYERS MUST BE SPACED PER DETAIL "A".
 - 1D. BOARD THICKNESS IS MEASURED INCLUDING TOP AND BOTTOM SIDES FINISHED COPPER. ANY TIN, TIN/LEAD OR GOLD PLATING, SOLDERMASK AND SILKSCREEN LEGEND MUST NOT BE INCLUDED IN FINISHED BOARD THICKNESS.
2. THE CONDUCTOR PATTERN MUST BE ETCHED USING ARTWORK 880011846-002 REV A SUPPLIED WITHIN FABRICATION FILES' ARCHIVE 885011846-002 REV A OR GREATER.
3. ALL CONDUCTOR LAYERS MUST BE REGISTERED WITHIN +/- .005 INCH FROM TRUE POSITION.
4. ETCH TOLERANCES:
 - 4A. ALL EXTERNAL LAYERS CONDUCTOR WIDTH MUST BE WITHIN +/- .0015 INCH OR +/- 15% OF GERBER DATA, WHICHEVER IS SMALLER.
5. BOARD MUST BE NC DRILLED USING DRILL DATA SUPPLIED.
6. DRILL TOLERANCES AND HOLE SIZES ARE FOR FINISHED BOARD:
 - ALL PLATED THROUGH HOLES TO .080 INCH ARE +/- .003 INCH.
 - ALL PLATED THROUGH HOLES OVER .081 INCH ARE +/- .005 INCH.
 - ALL NON-PLATED THROUGH HOLES ARE +/- .005 INCH.
7. ALL HOLES MUST BE REGISTERED WITHIN +/- .003 INCH FROM TRUE POSITION.
8. MINIMUM ANNULAR RING MUST BE .002 INCH.
9. PLATING:
 - 9A. PER MIL-C-14550, PLATED THROUGH HOLES MUST BE PLATED WITH .0008 MIN. TO .0015 INCH MAX. THICK COPPER.
 - 9B. FINISH: IMMERSION GOLD: 2 TO 8 MICROINCHES GOLD OVER 120-240 MICROINCHES OF ELECTROLESS NICKEL.
10. WARP AND TWIST OF FINISHED BOARDS MUST NOT EXCEED .007 INCH PER INCH.
11. SOLDERMASK: PER IPC-SM-840
 - 11A. SOLDERMASK BOTH TOP AND BOTTOM SIDES.
 - 11B. SOLDERMASK MUST CLEAR ALL LANDS SHOWN ON GERBER SOLDERMASK LAYERS, EXCEPT FOR BARREL TENTING ON 0.025 INCH VIA PADS.
 - 11C. COLOR GREEN AND SOLVENT FREE.
 - 11D. LIQUID PHOTO-IMAGEABLE MUST BE .0002 MIN. TO .0008 MAX. INCH THICK MEASURED OVER COPPER PLATING.
12. SILKSCREEN TOP AND BOTTOM SIDES USING A GLOSSY WHITE, NONCONDUCTIVE, EPOXY BASED INK. NO SILKSCREEN ALLOWED ON GOLD AREAS, ON PADS OR IN HOLES.
13. ROUTE BOARD OUTLINE, PER DRAWING DIMENSIONS.
14. VENDOR MUST ENTER VENDOR'S IDENTITY, DATE CODE AND ANY OTHER IDENTIFICATION MARKS ON BOTTOM SIDE ETCH APPROXIMATELY WHERE SHOWN.
15. OTHER VENDOR NOMENCLATURE OR MARKINGS SHOULD NOT BE ETCHED OR SILKSCREENED ON BOARD WITHOUT PRIOR PERMISSION.

REVISIONS			
REV	DESCRIPTION	DATE	APPD
A	Etch 002 Production Release	12/03/07	

16. ALL VENDOR IN-PROCESS MARKINGS, QA STAMPS, ETC. MUST BE PLACED ON THE BOTTOM SIDE OF BOARD.
17. FINISHED BOARD MUST MEET UL94V-0 RATING AND RoHS COMPLIANCE.
18. DOCUMENTATION THAT MUST BE DELIVERED WITH BOARDS:
 - 18A. CROSS SECTION REPORT (SPACING BETWEEN COPPER LAYERS AND COPPER THICKNESS)
 - 18B. ELECTRICAL TEST CERTIFICATION OF COMPLIANCE (ACCORDANCE WITH IPC-ET-652 CLASS II)
 - 18C. CERTIFICATION OF COMPLIANCE (BOARD HAS BEEN MANUFACTURED TO DRAWING REQUIREMENTS)
 - 18D. RoHS CERTIFICATE OF COMPLIANCE.



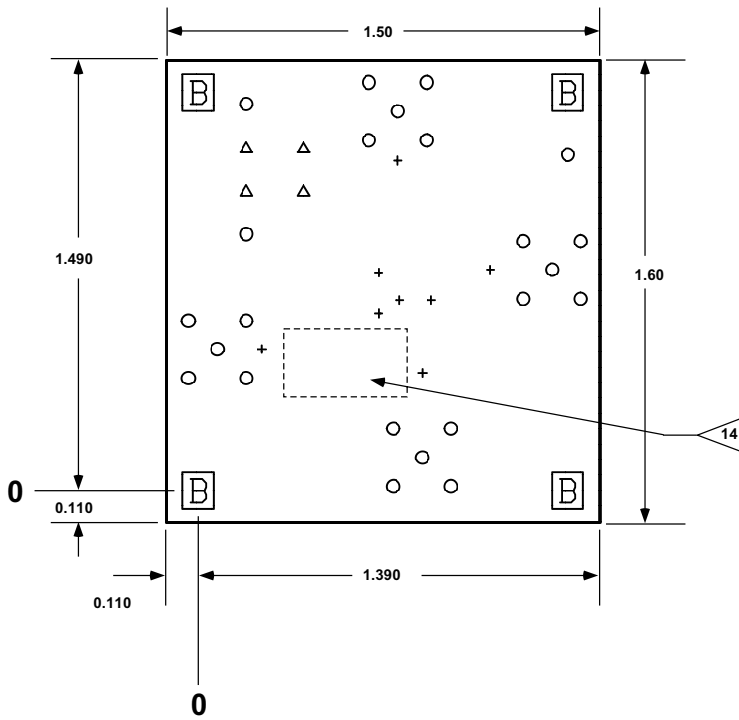
Board Fabrication Information	
	Smallest Feature
Air Gap	.010 inch
Trace Width	.015 inch
Hole Size	.025 inch
Pad Size	.024 x .06 inch
Surface Mount	Top & Bottom

UNLESS OTHERWISE SPECIFIED, ALL DIMENSIONS ARE IN INCHES

MATERIAL: SEE NOTES	DRAWN: Ernesto Rey	DATE: 03-Dec-07	BOARD & SYSTEM BUSINESS OPERATIONS	
FINISH: SEE NOTES	CHECKED:	DATE:	PCB FABRICATION DRAWING LMH730036 Eval	
TOLERANCES			ENGINEER: Bob Holtz	DATE:
1 PL ±.02	2 PL ±.01	3 PL ±.005	DO NOT COPY, DISPLAY, OR USE DRAWING WITHOUT AUTHORIZATION DO NOT SCALE DRAWING	
B	DRAWING: 551011846-002	A	SCALE: NONE	SHEET 1 OF 2 REV

REVISIONS

SEE SHEET #1



DRILL CHART			
ALL UNITS ARE IN INCHES			
SYM	SIZE	PLATED	QTY
+	0.025	YES	8
△	0.035	YES	4
○	0.055	YES	23
□	0.120	YES	4

		BOARD & SYSTEM BUSINESS OPERATIONS	
PCB FABRICATION DRAWING LMH730036 Eval			
B	DRAWING:	551011846-002	A
SCALE:	NONE	SHEET 2 OF 2	REV

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